

Features

- Single color.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Ideal for backlighting.
- Moisture sensitivity level : level 3.
- Package : 500pcs / reel.
- RoHS compliant.

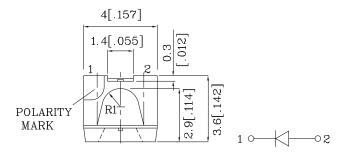


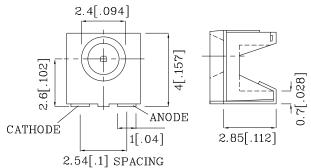


Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25(0.01") unless otherwise noted.
- 3. Specifications are subject to change without notice.

| Absolute Maximum Rating (TA=25°C) | UY (GaAsP/ GaP) | Unit | | |
|----------------------------------------------------------------|-----------------------|-----------|----|--|
| Reverse Voltage | VR | 5 | V | |
| Forward Current | IF | 30 | mA | |
| Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width | ifs | 140 | mA | |
| Power Dissipation | PD | 75 | mW | |
| Operating Temperature | ТА | -40 ~ +85 | °C | |
| Storage Temperature | Tstg | -40 ~ +85 | | |





| Operating Characteristics (TA=25°C) | | UY (GaAsP/GaP) | Unit |
|-----------------------------------------------------------------|-------------|-------------------|------|
| Forward Voltage (Typ.) (IF=20mA) | $V_{\rm F}$ | 2.1 | V |
| Forward Voltage (Max.) (IF=20mA) | $V_{\rm F}$ | 2.5 | V |
| Reverse Current (Max.) (VR=5V) | IR | 10 | uA |
| Wavelength of Peak Emission (Typ.) (IF=20mA) | λΡ | 590 | nm |
| Wavelength of Dominant Emission (Typ.) (IF=20mA) | λ D | 588 | nm |
| Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA) | Δλ | 35 | nm |
| Capacitance (Typ.) (VF=0V, f=1MHz) | С | 20 | pF |

| Part Number | Emitting Color | Emitting Material | Lens-color | Luminous Intensity (IF=20mA) mcd | | Wavelength nm λ P | Viewing Angle 2 θ 1/2 |
|----------------|-------------------|----------------------|-------------|-------------------------------------------|------|-------------------------|-----------------------------|
| | | | | min. | typ. | | |
| XZUY67S | Yellow | GaAsP/GaP | Water Clear | 10 | 14 | 590 | 120° |

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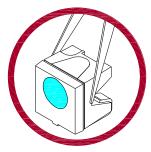


Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

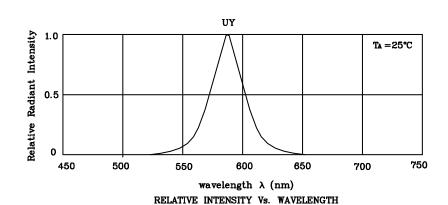




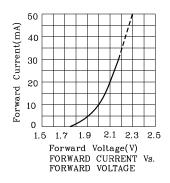
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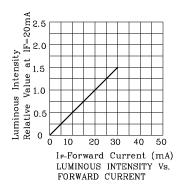


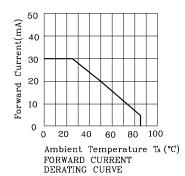


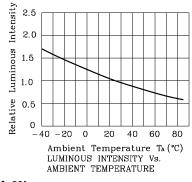


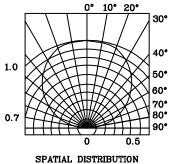
& UY









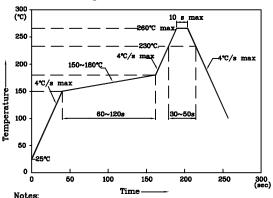


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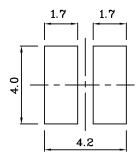


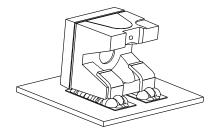
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



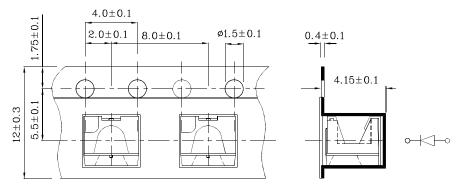
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions
- **❖** Recommended Soldering Pattern (Units: mm;Tolerance:± 0.1)
- **❖** The device has a single mounting surface. The device must be mounted according to the specifications.





* Tape Specification (Units:mm)

TAPE



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

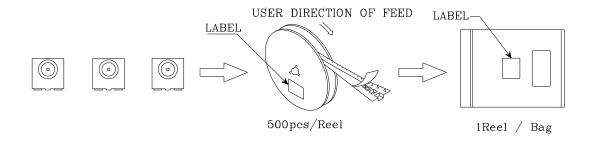
Note: Accuracy may depend on the sorting parameters.

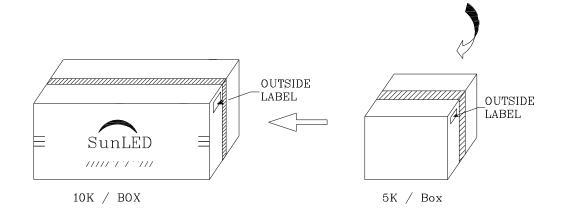
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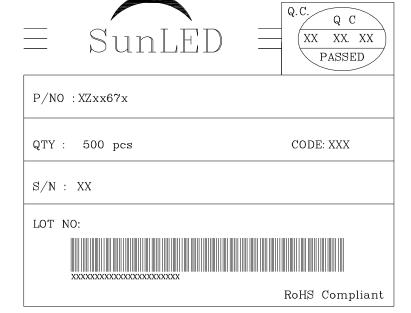


PACKING & LABEL SPECIFICATIONS

XZUY67S







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